

## MOSFET

Metal Oxide Semiconductor Field Effect Transistor

### CoolMOS™ E6 600V

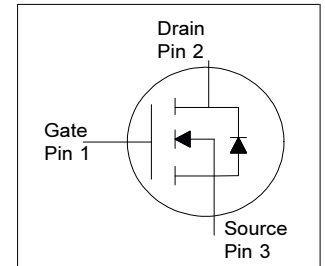
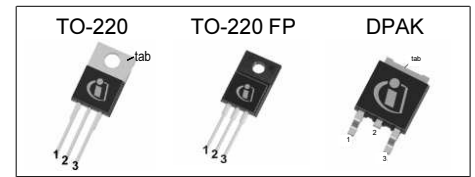
600V CoolMOS™ E6 Power Transistor  
IPx60R380E6

## Data Sheet

Rev. 2.5  
Final

## 1 Description

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ E6 series combines the experience of the leading SJ MOSFET supplier with high class innovation. The resulting devices provide all benefits of a fast switching SJ MOSFET while not sacrificing ease of use. Extremely low switching and conduction losses make switching applications even more efficient, more compact, lighter and cooler.



## Features

- Extremely low losses due to very low FOM  $R_{ds(on)} \cdot Q_g$  and  $E_{oss}$
- Very high commutation ruggedness
- Easy to use/drive
- Pb-free plating, Halogen free mold compound (except PG-TO252)
- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)



## Applications

PFC stages, hard switching PWM stages and resonant switching PWM stages for e.g. PC Silverbox, Adapter, LCD & PDP TV, Lighting, Server, Telecom and UPS.



**Table 1 Key Performance Parameters**

| Parameter            | Value | Unit       |
|----------------------|-------|------------|
| $V_{DS} @ T_{j,max}$ | 650   | V          |
| $R_{DS(on),max}$     | 0.38  | $\Omega$   |
| $Q_g,typ$            | 32    | nC         |
| $I_{D,pulse}$        | 30    | A          |
| $E_{oss} @ 400V$     | 2.8   | $\mu J$    |
| Body diode $di/dt$   | 500   | A/ $\mu s$ |

| Type / Ordering Code | Package           | Marking | Related Links  |
|----------------------|-------------------|---------|----------------|
| IPP60R380E6          | PG-TO 220         | 6R380E6 | see Appendix A |
| IPA60R380E6          | PG-TO 220 FullPAK |         |                |
| IPD60R380E6          | PG-TO 252         |         |                |



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## 2 Maximum ratings

at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                 | Symbol         | Values |      |      | Unit             | Note / Test Condition  |
|---|----------------|--------|------|------|------------------|--|
|   |                | Min.   | Typ. | Max. |                  |  |
| Continuous drain current <sup>1)</sup>    | $I_D$          |        |      | 10.6 | A                | $T_C = 25^\circ\text{C}$   |
|   |                |        |      | 6.7  |                  | $T_C = 100^\circ\text{C}$  |
| Pulsed drain current <sup>2)</sup>        | $I_{D,pulse}$  |        |      | 30   | A                | $T_C = 25^\circ\text{C}$   |
| Avalanche energy, single pulse            | $E_{AS}$       |        |      | 210  | mJ               | $I_D = 1.8\text{A}$ , $V_{DD} = 50\text{V}$<br>(see table 22)                                      |
| Avalanche energy, repetitive              | $E_{AR}$       |        |      | 0.32 | mJ               | $I_D = 1.8\text{A}$ , $V_{DD} = 50\text{V}$  |
| Avalanche current, repetitive             | $I_{AR}$       |        |      | 1.8  | A                |  |
| MOSFET dv/dt ruggedness                   | dv/dt          |        |      | 50   | V/ns             | $V_{DS} = 0 \dots 480\text{V}$   |
| Gate source voltage                       | $V_{GS}$       | -20    |      | 20   | V                | static   |
|   |                | -30    |      | 30   |                  | AC ( $f > 1\text{Hz}$ )  |
| Power dissipation (non FullPAK)<br>TO-220 | $P_{tot}$      |        |      | 83   | W                | $T_C = 25^\circ\text{C}$   |
| Power dissipation (FullPAK)<br>TO-220 FP  | $P_{tot}$      |        |      | 31   | W                | $T_C = 25^\circ\text{C}$   |
| Operating and storage temperature         | $T_j, T_{stg}$ | -55    |      | 150  | $^\circ\text{C}$ |  |
| Mounting torque (non FullPAK)<br>TO-220   |                |        |      | 60   | Ncm              | M3 and M3.5 screws   |
| Mounting torque (FullPAK)<br>TO-220 FP    |                |        |      | 50   | Ncm              | M2.5 screws  |
| Continuous diode forward current          | $I_S$          |        |      | 9.2  | A                | $T_C = 25^\circ\text{C}$   |
| Diode pulse current                       | $I_{S,pulse}$  |        |      | 30   | A                | $T_C = 25^\circ\text{C}$   |
| Reverse diode dv/dt <sup>3)</sup>         | dv/dt          |        |      | 15   | V/ns             | $V_{DS} = 0 \dots 480\text{V}$ , $I_{SD} \leq I_D$ ,<br>$T_j = 25^\circ\text{C}$<br>(see table 20) |
| Maximum diode commutation speed           | di/dt          |        |      | 500  | A/ $\mu\text{s}$ |  |

<sup>1)</sup> Limited by  $T_{j,max}$ . Maximum duty cycle  $D=0.75$

<sup>2)</sup> Pulse width  $t_p$  limited by  $T_{j,max}$

<sup>3)</sup> Identical low side and high side switch with identical  $R_G$

### 3 Thermal characteristics

**Table 3 Thermal characteristics TO-220**

| Parameter  | Symbol     | Values |      |      | Unit | Note / Test Condition                |
|--|------------|--------|------|------|------|--------------------------------------|
|  |            | Min.   | Typ. | Max. |      |                                      |
| Thermal resistance, junction - case                        | $R_{thJC}$ |        |      | 1.5  | °C/W |                                      |
| Thermal resistance, junction - ambient                     | $R_{thJA}$ |        |      | 62   | °C/W | lead                                 |
| Soldering temperature, wavesoldering only allowed at leads | $T_{sold}$ |        |      | 260  | °C   | 1.6 mm (0.063 in.) from case for 10s |

**Table 4 Thermal characteristics TO-220 FP**

| Parameter  | Symbol     | Values |      |      | Unit | Note / Test Condition                |
|--|------------|--------|------|------|------|--------------------------------------|
|  |            | Min.   | Typ. | Max. |      |                                      |
| Thermal resistance, junction - case                        | $R_{thJC}$ |        |      | 4.0  | °C/W |                                      |
| Thermal resistance, junction - ambient                     | $R_{thJA}$ |        |      | 80   | °C/W | lead                                 |
| Soldering temperature, wavesoldering only allowed at leads | $T_{sold}$ |        |      | 260  | °C   | 1.6 mm (0.063 in.) from case for 10s |

**Table 5 Thermal characteristics DPAK**

| Parameter  | Symbol     | Values |      |      | Unit | Note / Test Condition                                     |
|--|------------|--------|------|------|------|---|
|  |            | Min.   | Typ. | Max. |      |   |
| Thermal resistance, junction - case                    | $R_{thJC}$ |        |      | 1.5  | °C/W |   |
| Thermal resistance, junction - ambient <sup>1)</sup>   | $R_{thJA}$ |        |      | 62   | °C/W | SMD version, device on PCB, minimal footprint             |
|  |            |        | 35   |      |      | SMD version, device on PCB, 6cm <sup>2</sup> cooling area |
| Soldering temperature, wave- & reflowsoldering allowed | $T_{sold}$ |        |      | 260  | °C   | reflow MSL  |

<sup>1)</sup> Device on 40mm\*40mm\*1.5mm one layer epoxy PCB FR4 with 6cm<sup>2</sup> copper area (thickness 70µm) for drain connection. PCB is vertical without air stream cooling.

## 4 Electrical characteristics

at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

**Table 6 Static characteristics**

| Parameter                        | Symbol        | Values |       |      | Unit     | Note / Test Condition                           |
|----------------------------------|---------------|--------|-------|------|----------|---|
|                                  |               | Min.   | Typ.  | Max. |          |   |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | 600    |       |      | V        | $V_{GS} = 0V, I_D = 0.25mA$                     |
| Gate threshold voltage           | $V_{GS(th)}$  | 2.5    | 3     | 3.5  | V        | $V_{DS} = V_{GS}, I_D = 0.3mA$                  |
| Zero gate voltage drain current  | $I_{DSS}$     |        |       | 1    | $\mu A$  | $V_{DS} = 600V, V_{GS} = 0V, T_j = 25^\circ C$  |
|                                  |               |        | 10    |      |          | $V_{DS} = 600V, V_{GS} = 0V, T_j = 150^\circ C$ |
| Gate-source leakage current      | $I_{GSS}$     |        |       | 100  | nA       | $V_{GS} = 20V, V_{DS} = 0V$                     |
| Drain-source on-state resistance | $R_{DS(on)}$  |        | 0.340 | 0.38 | $\Omega$ | $V_{GS} = 10V, I_D = 3.8A, T_j = 25^\circ C$    |
|                                  |               |        | 0.890 |      |          | $V_{GS} = 10V, I_D = 3.8A, T_j = 150^\circ C$   |
| Gate resistance                  | $R_G$         |        | 7.5   |      | $\Omega$ | $f = 1MHz, \text{open drain}$                   |

**Table 7 Dynamic characteristics**

| Parameter  | Symbol       | Values |      |      | Unit | Note / Test Condition  |
|--|--------------|--------|------|------|------|--|
|  |              | Min.   | Typ. | Max. |      |  |
| Input capacitance  | $C_{iss}$    |        | 700  |      | pF   | $V_{GS} = 0V, V_{DS} = 100V, f = 1MHz$                                       |
| Output capacitance   | $C_{oss}$    |        | 46   |      | pF   |  |
| Effective output capacitance, energy related <sup>1)</sup> | $C_{o(er)}$  |        | 30   |      | pF   | $V_{GS} = 0V, V_{DS} = 0 \dots 480V$   |
| Effective output capacitance, time related <sup>2)</sup>   | $C_{o(tr)}$  |        | 136  |      | pF   | $I_D = \text{constant}, V_{GS} = 0V, V_{DS} = 0 \dots 480V$                  |
| Turn-on delay time   | $t_{d(on)}$  |        | 11   |      | ns   | $V_{DD} = 400V, V_{GS} = 13V, I_D = 4.8A, R_G = 3.4\Omega$<br>(see table 22) |
| Rise time  | $t_r$        |        | 9    |      | ns   |  |
| Turn-off delay time  | $t_{d(off)}$ |        | 56   |      | ns   |  |
| Fall time  | $t_f$        |        | 8    |      | ns   |  |

**Table 8 Gate charge characteristics**

| Parameter             | Symbol        | Values |      |      | Unit | Note / Test Condition                                   |
|-----------------------|---------------|--------|------|------|------|---|
|                       |               | Min.   | Typ. | Max. |      |   |
| Gate to source charge | $Q_{gs}$      |        | 4    |      | nC   | $V_{DD} = 480V, I_D = 4.8A, V_{GS} = 0 \text{ to } 10V$ |
| Gate to drain charge  | $Q_{gd}$      |        | 16   |      | nC   |   |
| Gate charge total     | $Q_g$         |        | 32   |      | nC   |   |
| Gate plateau voltage  | $V_{plateau}$ |        | 5.4  |      | V    |   |

<sup>1)</sup>  $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{(BR)DSS}$

<sup>2)</sup>  $C_{o(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{(BR)DSS}$

**Table 9 Reverse diode characteristics**

| Parameter                     | Symbol    | Values |      |      | Unit    | Note / Test Condition   |
|-------------------------------|-----------|--------|------|------|---------|---|
|                               |           | Min.   | Typ. | Max. |         |   |
| Diode forward voltage         | $V_{SD}$  |        | 0.9  |      | V       | $V_{GS} = 0V, I_F = 4.8A, T_j = 25^\circ C$                           |
| Reverse recovery time         | $t_{rr}$  |        | 290  |      | ns      | $V_R = 400V, I_F = 4.8A,$<br>$di_F/dt = 100A/\mu s$<br>(see table 20) |
| Reverse recovery charge       | $Q_{rr}$  |        | 3.3  |      | $\mu C$ |   |
| Peak reverse recovery current | $I_{rrm}$ |        | 21   |      | A       |   |

## 5 Electrical characteristics diagrams

Table 10

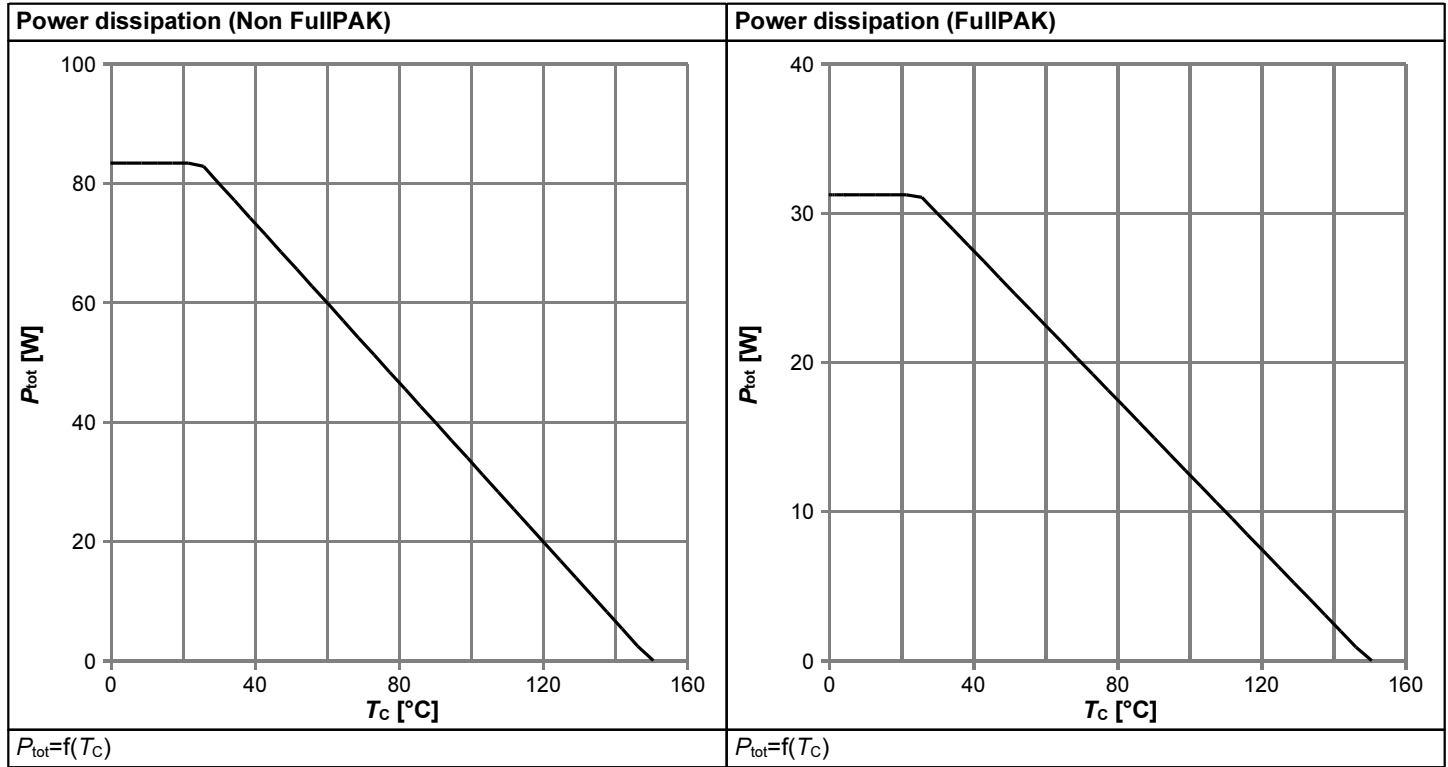


Table 11

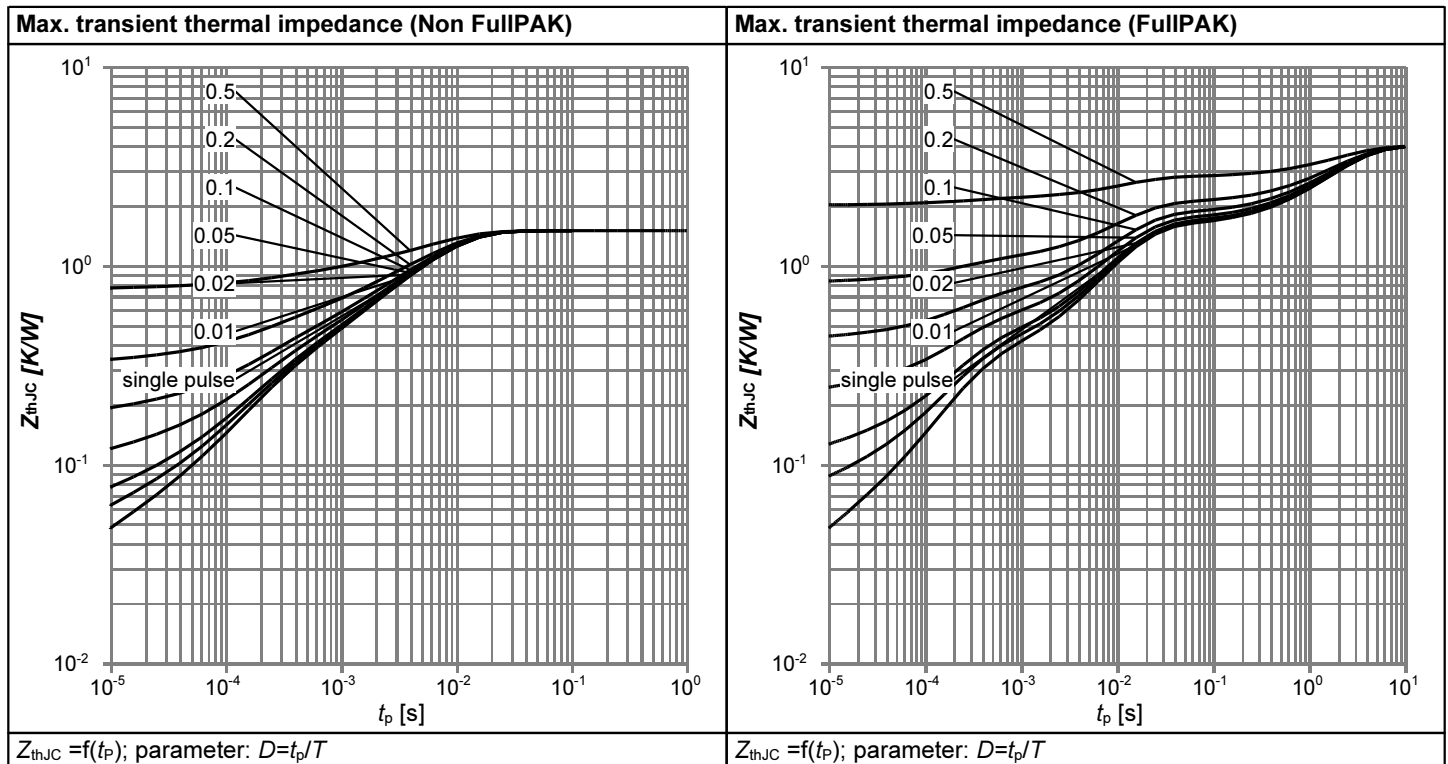




Table 12

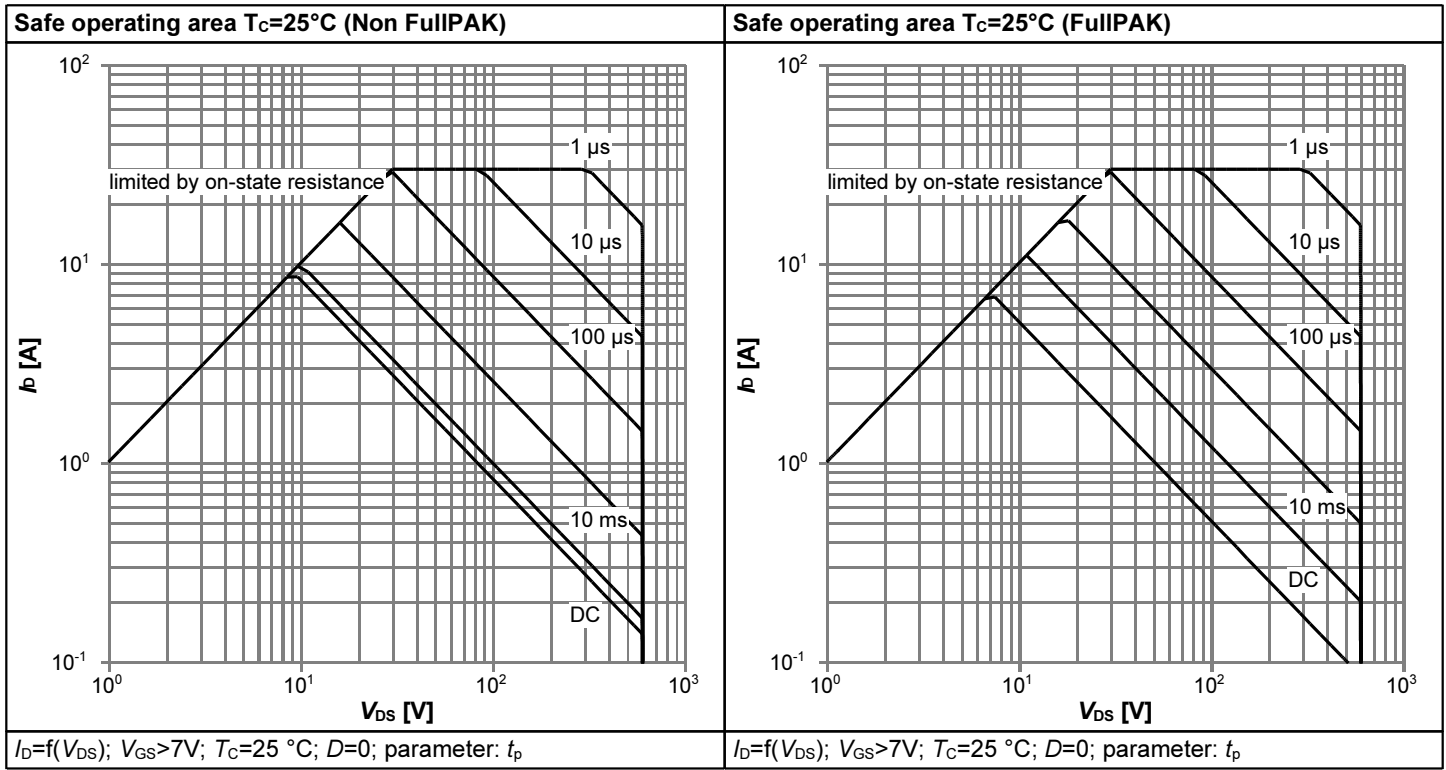


Table 13

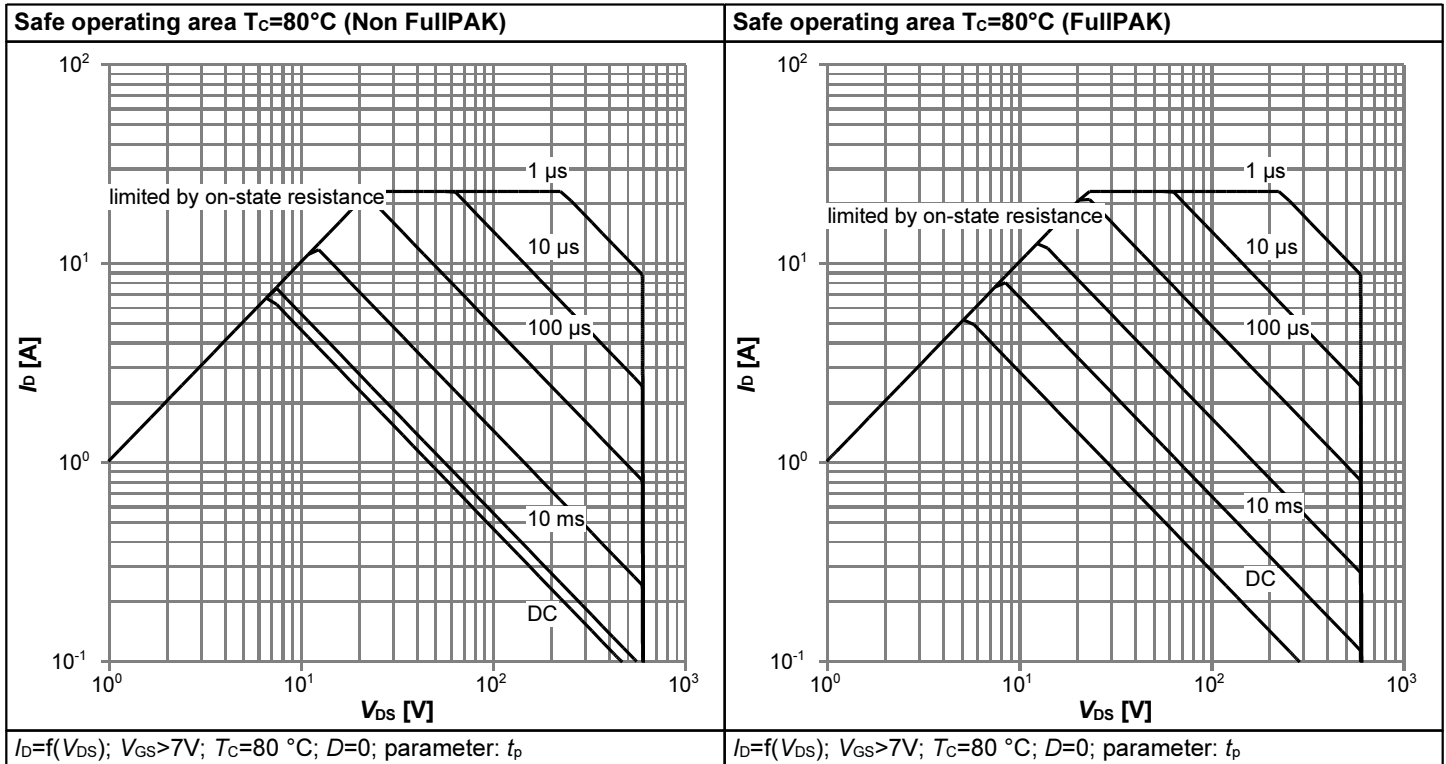


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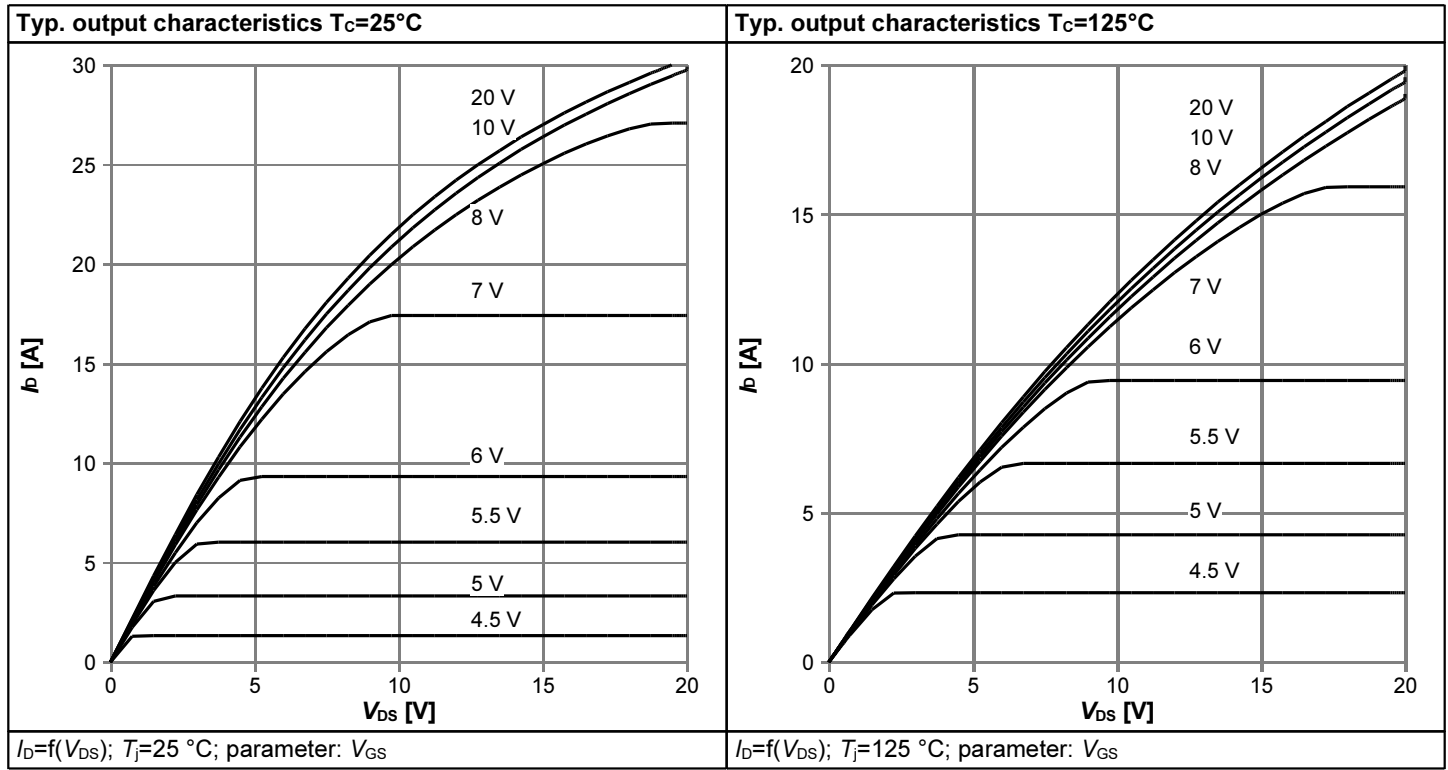


Table 15

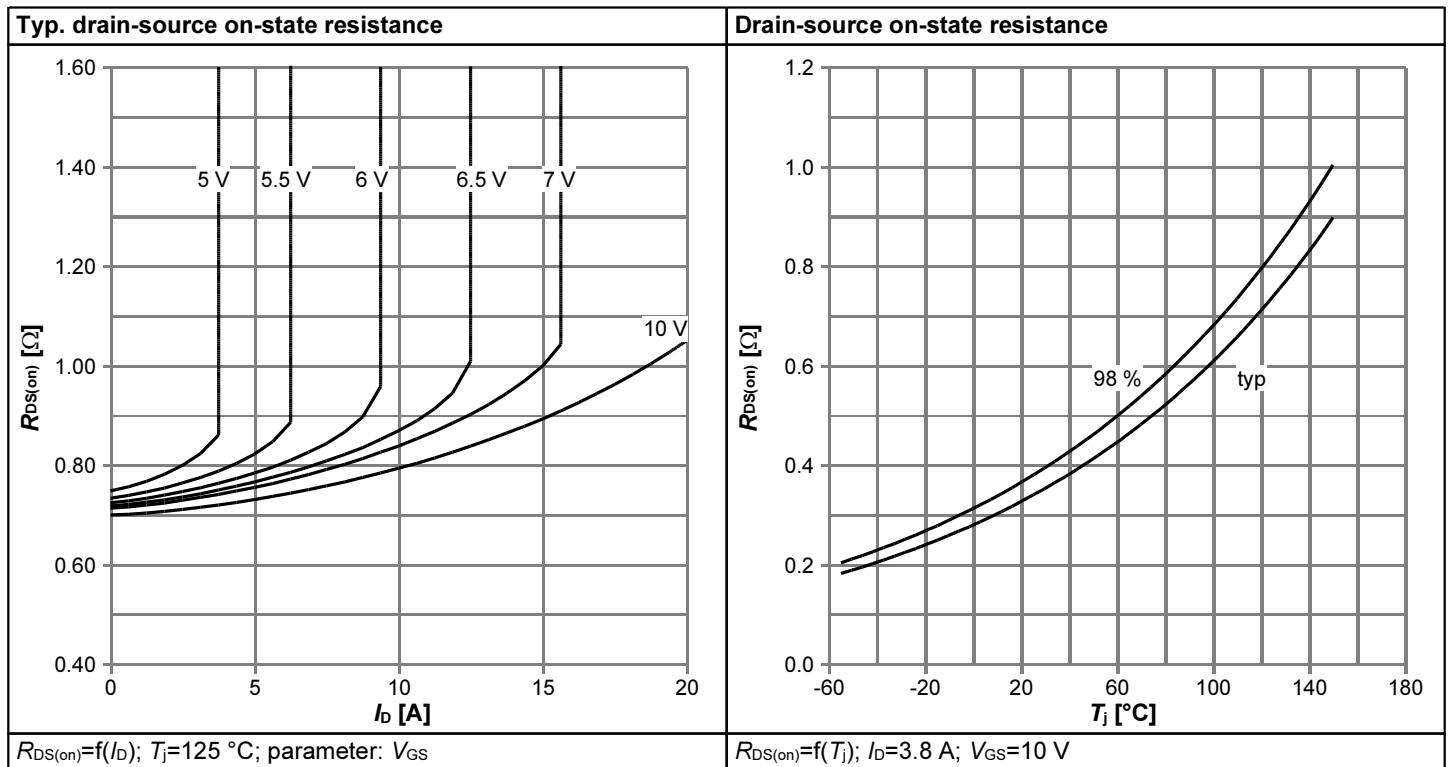


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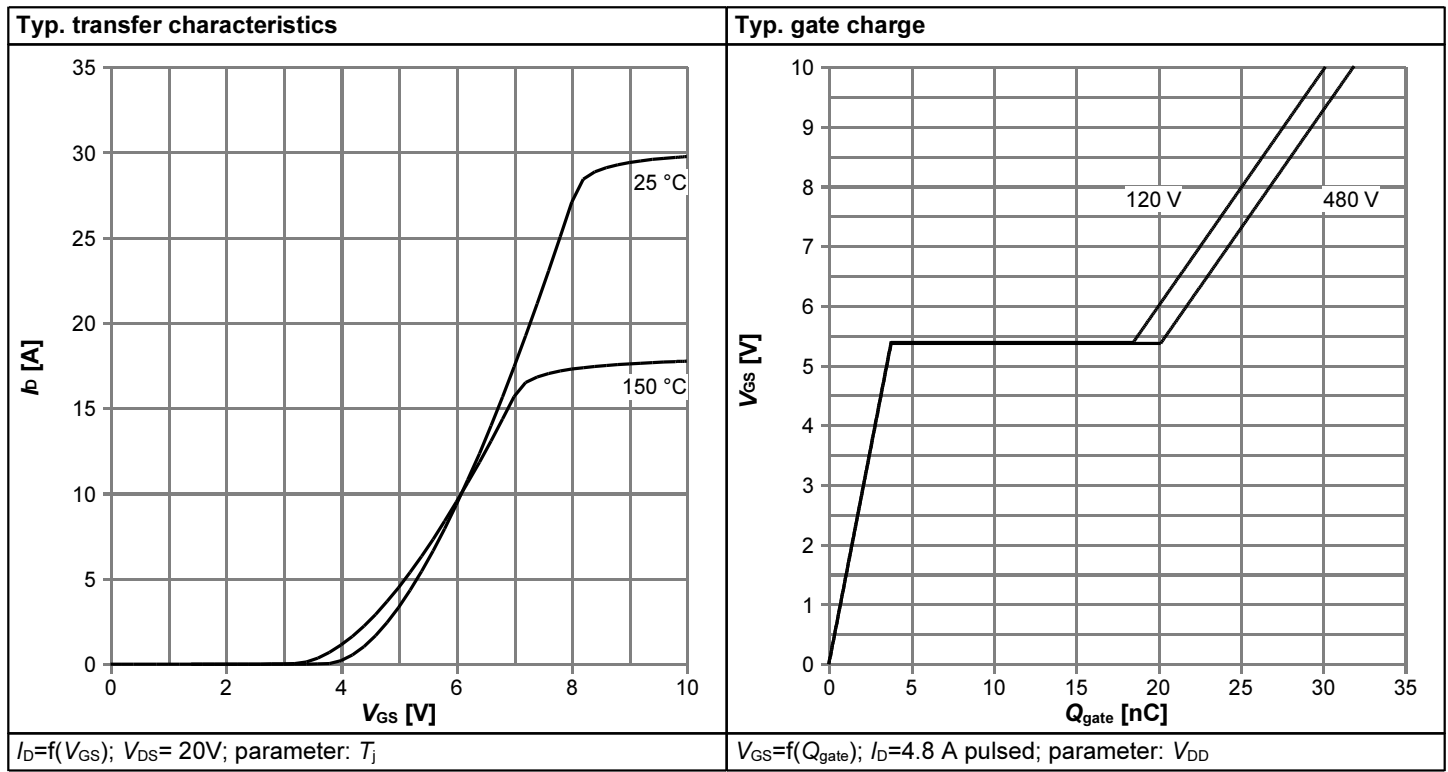
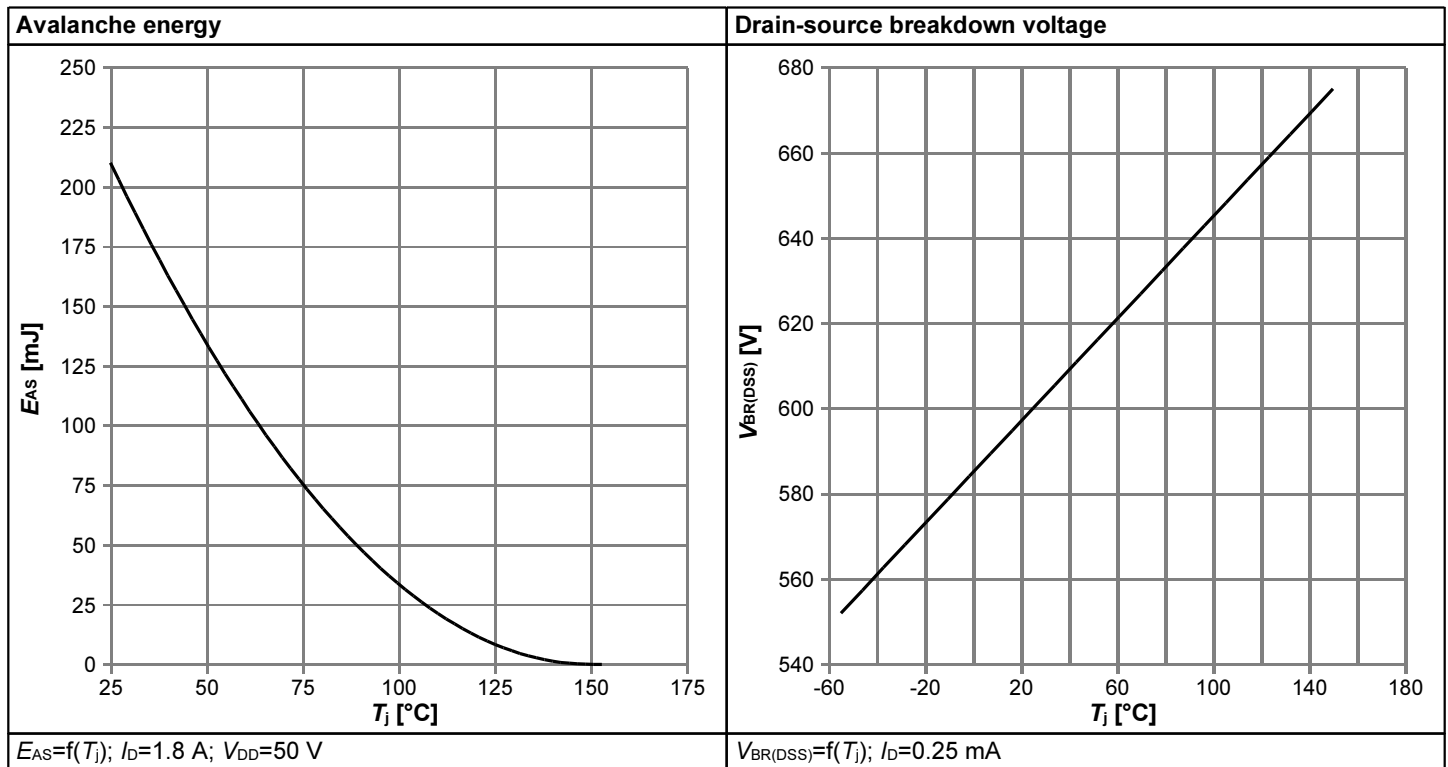
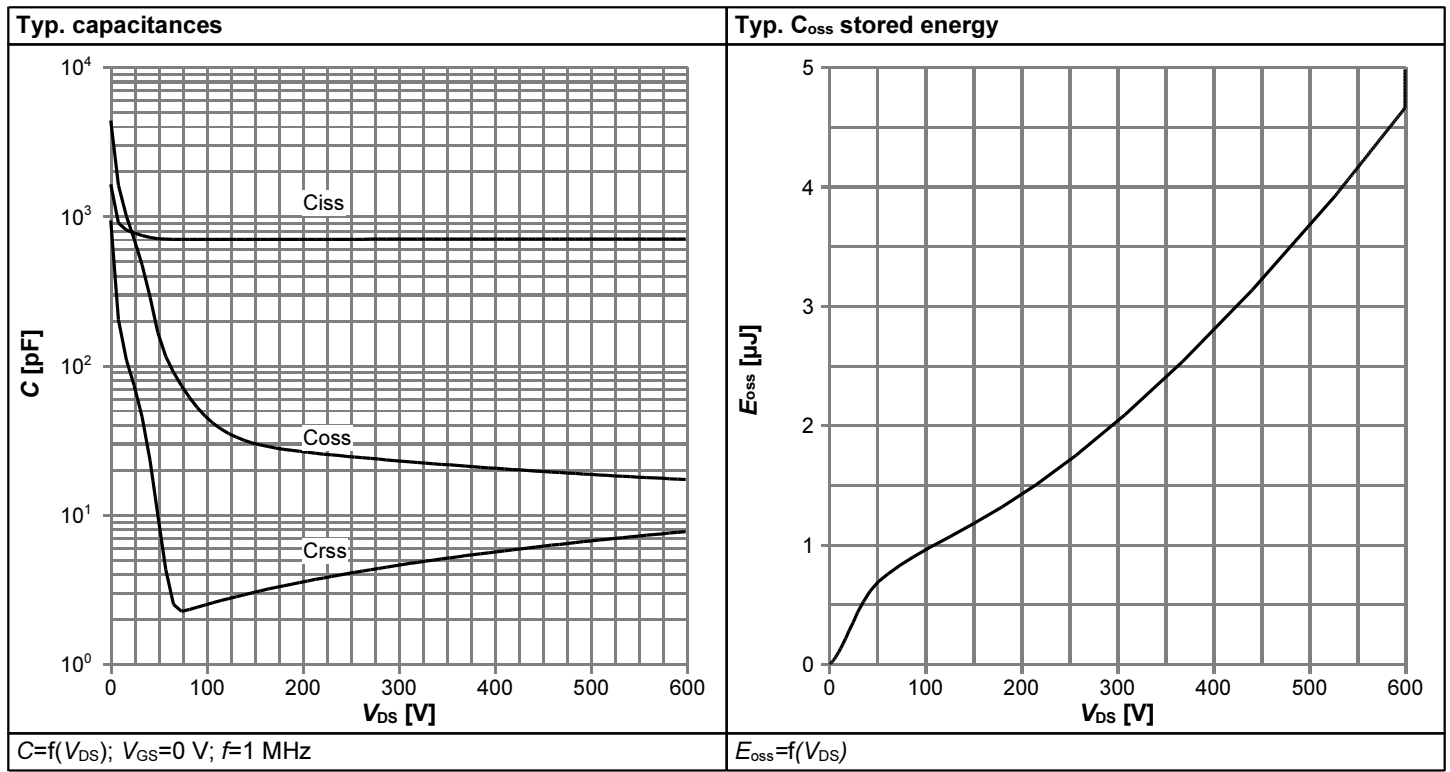


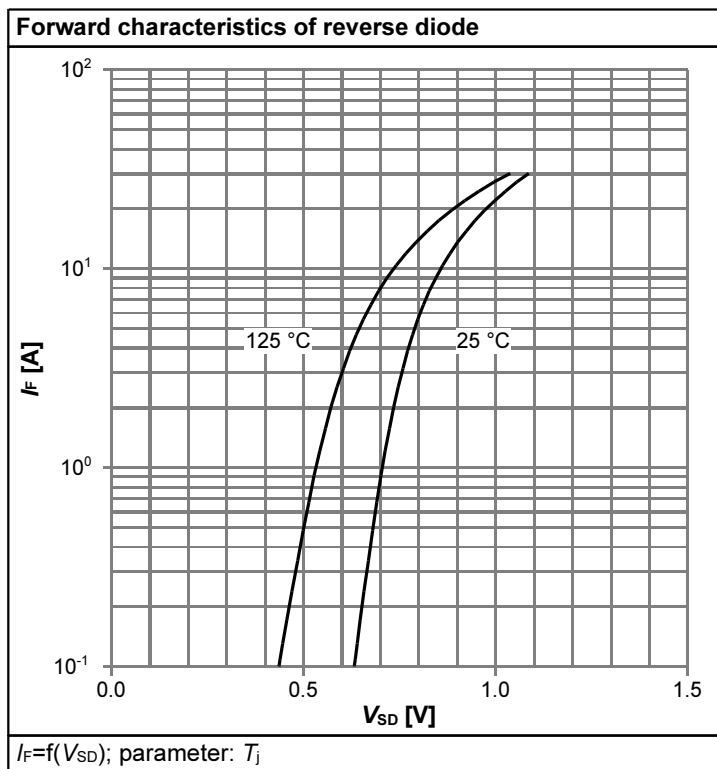
Table 17



**Table 18**



**Table 19**



6 Test Circuits

Table 20 Diode characteristics

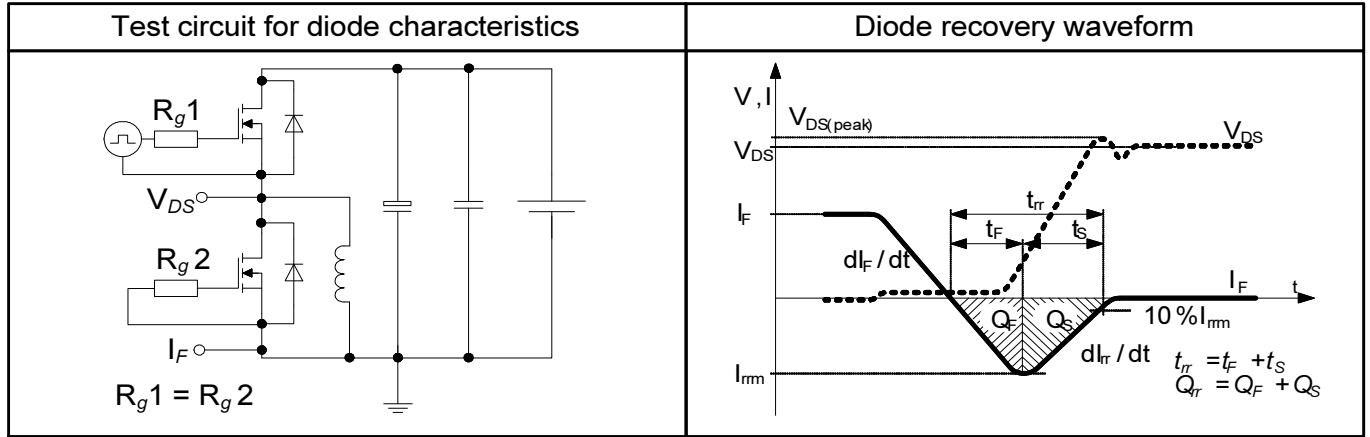


Table 21 Switching times

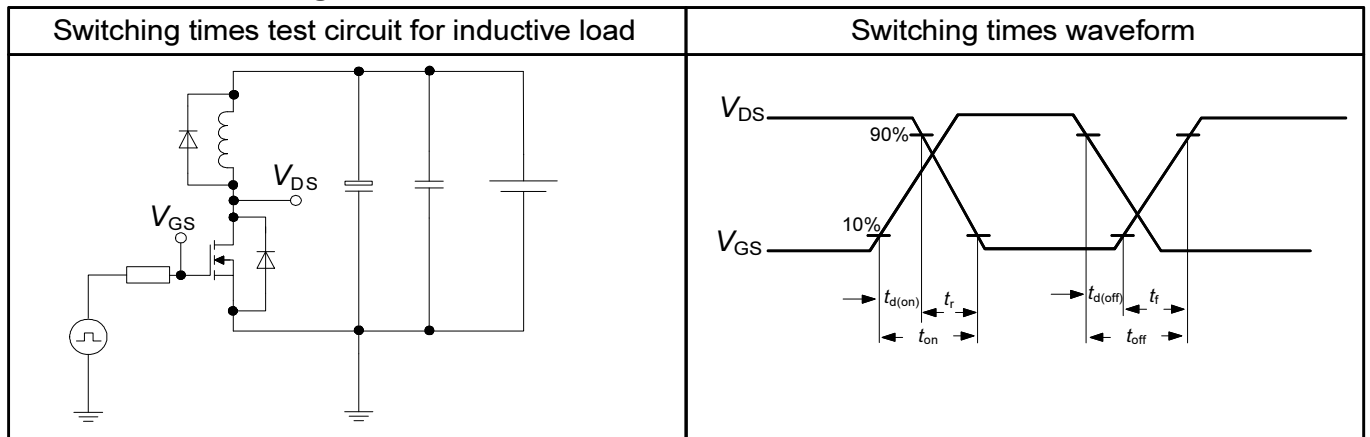
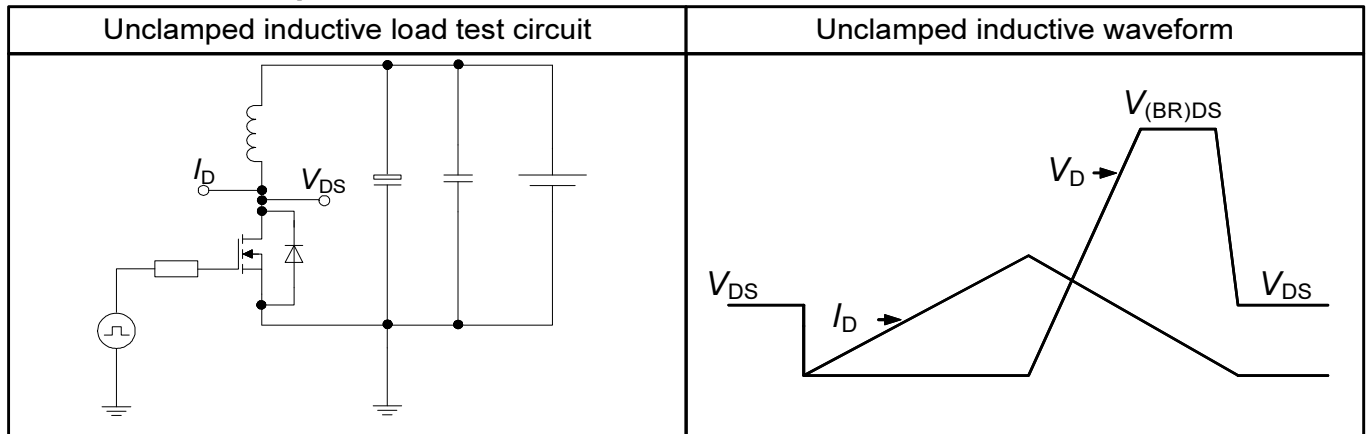


Table 22 Unclamped inductive load



## 7 Package Outlines

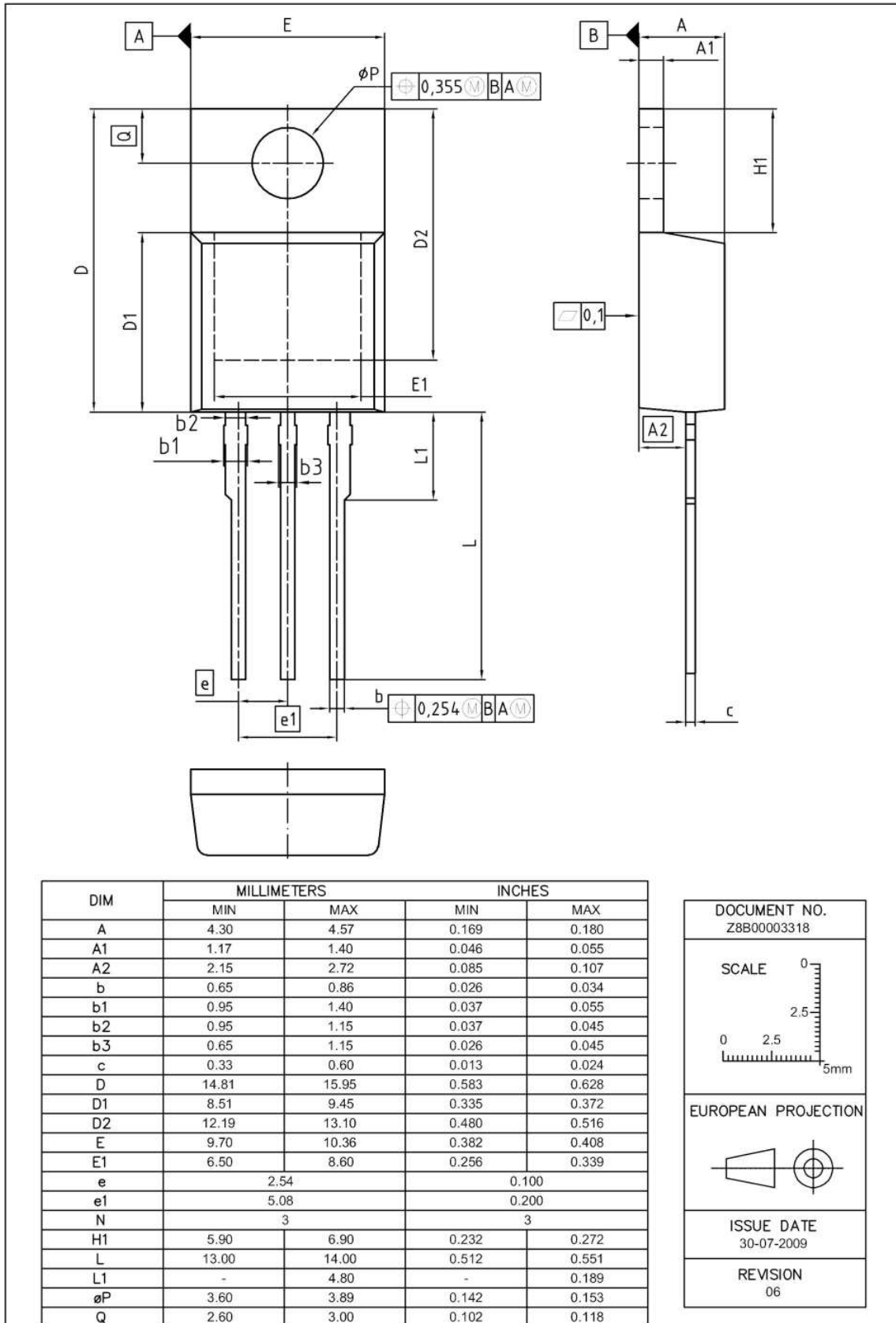
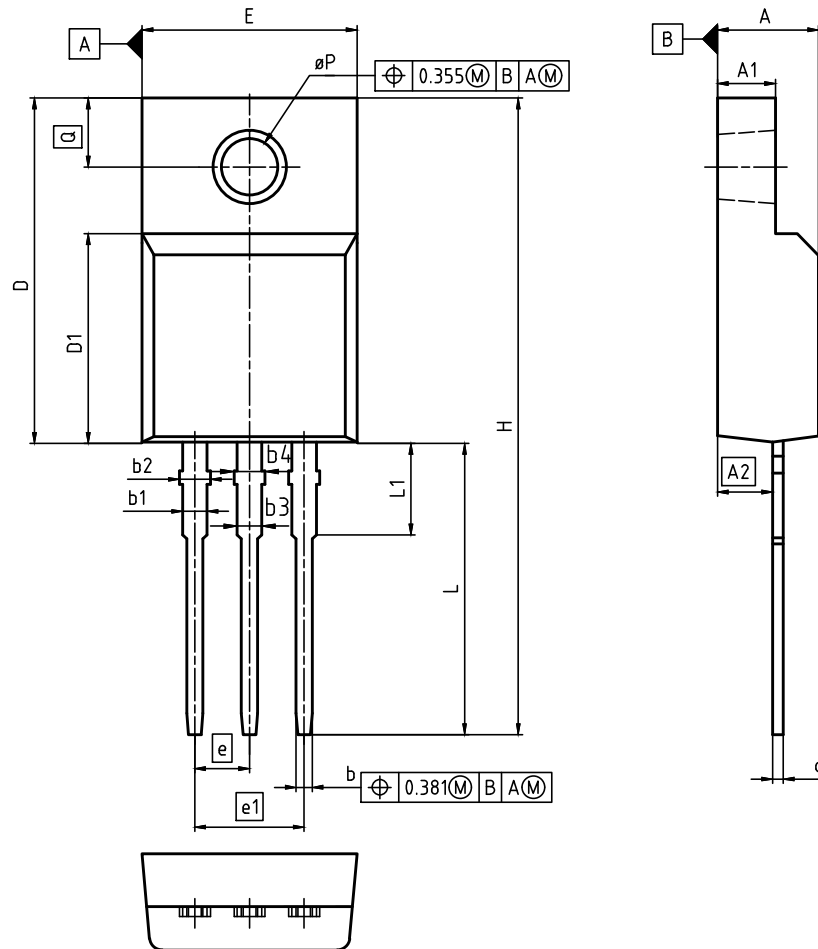


Figure 1 Outline PG-TO 220, dimensions in mm/inches



| DIM | MILLIMETERS |       | INCHES      |       |
|-----|-------------|-------|-------------|-------|
|     | MIN         | MAX   | MIN         | MAX   |
| A   | 4.50        | 4.90  | 0.177       | 0.193 |
| A1  | 2.34        | 2.85  | 0.092       | 0.112 |
| A2  | 2.42        | 2.86  | 0.095       | 0.113 |
| b   | 0.65        | 0.90  | 0.026       | 0.035 |
| b1  | 0.95        | 1.38  | 0.037       | 0.054 |
| b2  | 0.95        | 1.51  | 0.037       | 0.059 |
| b3  | 0.65        | 1.38  | 0.026       | 0.054 |
| b4  | 0.65        | 1.51  | 0.026       | 0.059 |
| c   | 0.40        | 0.63  | 0.016       | 0.025 |
| D   | 15.67       | 16.15 | 0.617       | 0.636 |
| D1  | 8.97        | 9.83  | 0.353       | 0.387 |
| E   | 10.00       | 10.65 | 0.394       | 0.419 |
| e   | 2.54 (BSC)  |       | 0.100 (BSC) |       |
| e1  | 5.08        |       | 0.200       |       |
| N   | 3           |       | 3           |       |
| H   | 28.70       | 29.75 | 1.130       | 1.171 |
| L   | 12.78       | 13.75 | 0.503       | 0.541 |
| L1  | 2.83        | 3.45  | 0.111       | 0.136 |
| øP  | 2.95        | 3.38  | 0.116       | 0.133 |
| Q   | 3.15        | 3.50  | 0.124       | 0.138 |

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Figure 2 Outline PG-TO 220 FullPAK, dimensions in mm/inches

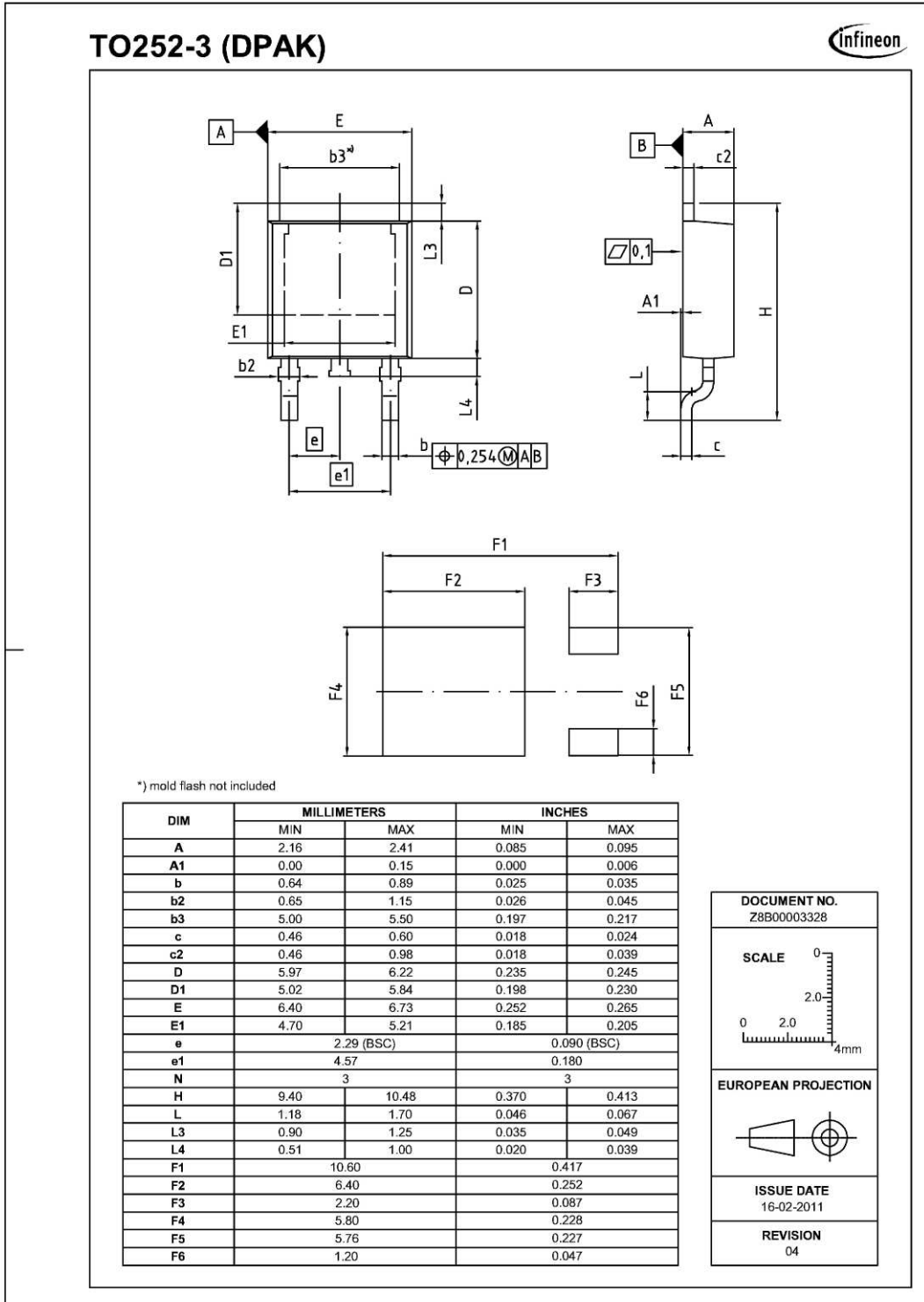


Figure 3 Outline PG-TO 252, dimensions in mm/inches



## 8 Appendix A

### Table 23 Related Links

- IFX CoolMOS Webpage: [www.infineon.com](http://www.infineon.com)
- IFX Design Tools: [www.infineon.com](http://www.infineon.com)

## Revision History

IPx60R380E6

**Revision: 2015-02-09, Rev. 2.5**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision)                  |
|----------|------------|---|
| 2.0      | 2011-06-08 | Release Final data sheet                                      |
| 2.1      | 2011-09-14 | -   |
| 2.2      | 2011-09-14 | -   |
| 2.3      | 2011-09-20 | -   |
| 2.4      | 2013-05-15 | PG-TO252 Package Added  |
| 2.5      | 2015-02-09 | PG-TO220 FullPAK package outline update (creation:2014-12-09) |

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